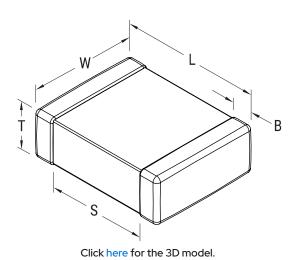




ESD SMD Comm X7R, Ceramic, 0.015 uF, 10%, 16 VDC, X7R, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II, 0603, 0.5 mm



General Information	
Series	ESD SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	4.8 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.07mm
S	0.5mm MIN
В	0.35mm +/-0.15mm

Bulk, Bag

Packa Packaging

**Packaging Quantity** 

aging Specifications		Temp. Coefficient
		Temperature Range
	0.35mm +/-0.15mm	Dielectric Withstand
	0.5mm MIN	ESD Level per AEC-
	0.8mm +/-0.07mm	Voltage DC
	0.8mm +/-0.15mm	Tolerance
	1.6mm +/-0.15mm	Measurement Cond

Specifications	
Capacitance	0.015 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	16 VDC
ESD Level per AEC-Q200	16,000 V ESD Level
Dielectric Withstanding Voltage	40 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	3.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	66.6667 GOhms

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